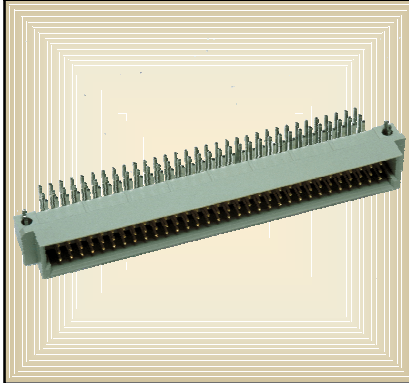


**THROUGH-HOLE SOLDERING
SOLDERLESS (PRESS-FIT) CONNECTORS**

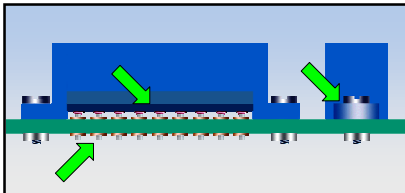


SOLDERLESS (PRESS-FIT) CONNECTORS

The use of high-density, high pin-count connectors (i.e.: backplane connectors, PC104, etc.) in multi-layer boards presents a technical challenge to the designer. The close pin geometries and thermal mass make reliable soldering extremely difficult.

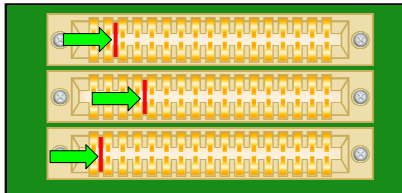
Press-fit technology offers a "solderless" alternative, with spring-pin terminations that produce a reliable electrical termination with a gas-tight, mechanical fit to the plated-through hole.

Press-fit technology shall not be specified for flight applications without prior NASA approval.



**PREFERRED
GENERAL REQUIREMENTS**

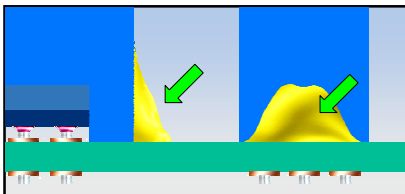
The connector has been properly installed, parallel to, and in full contact with the mounting surface. Pins are fully inserted, even, and meet minimum protrusion requirements. Mounting features (i.e.: board lock tabs or fasteners) have been fully inserted and set.



**PREFERRED
KEYING**

Connectors should be keyed to prevent incorrect mating / interchanging with similar sized / colored connectors.

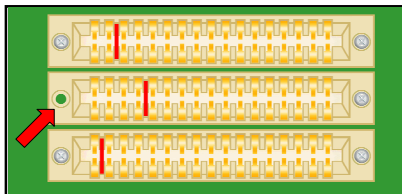
[Best Workmanship Practice](#)



**ACCEPTABLE
ALTERNATIVE MECHANICAL MOUNTING**

Connectors not supplied with a locking tab or fastener system shall be secured with staking compound. Staking compound shall not be applied over conductive surfaces.

[Best Workmanship Practice](#)



**UNACCEPTABLE
MISSING MOUNTING / CONNECTING
HARDWARE**

Missing mounting / connecting hardware can interfere with the proper mating of the connector.

[Best Workmanship Practice](#)

NASA WORKMANSHIP STANDARDS

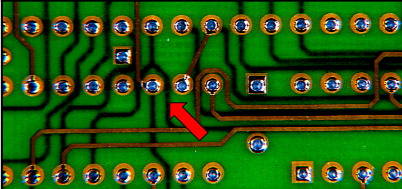


NATIONAL AERONAUTICS AND
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**THROUGH-HOLE SOLDERING
SOLDERLESS (PRESS-FIT) CONNECTORS (cont.)**




**UNACCEPTABLE
SOLDERED TERMINATIONS**

Solderless terminations are specifically designed for termination in plated-through holes (PTH) without soldering. The special design will prohibit the formation of a properly wetted solder interface between the pin and the PTH wall.

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NASA WORKMANSHIP STANDARDS

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